

Product Qualification Report

BFP182W

Low Noise Silicon Bipolar RF Transistor

Description

This product qualification report describes the characteristics of the product with respect to quality and reliability.

The qualification sample selection was done on production lots which were manufactured and tested on standard production processes and meet the defined requirements.

The qualification test results of those products as outlined in this document are based on **AECQ101** for target applications and may reference existing qualification results of similar products. Such referencing is justified by the structural similarity of the products.

Qualification Assessment

Qualified acc. **AEC Q101** and assessed as PASS

For further information about comparable products, please contact the nearest Infineon Technologies office (www.infineon.com).

BFP182W
Package: PG-SOT343-4
MSL: 1

qualified before 2010

Electrical Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/ss | Fail/Qty | Result |
|--|-------|---------------------------------|----------|---------|----------|--------|
| Electrical Distribution | ED | -55°C, +25°C, +150°C | | 1 x 30 | 0 / 30 | PASS |
| High Humidity High Temperature Reverse Bias JESD22 A101 | H3TRB | T=85°C, RH=85% | 1000 h | 4 x 60 | 0 / 240 | PASS |
| High Temperature Reverse Bias JESD22 A108 | HTRB | Ta=150°C | 1000 h | 4 x 60 | 0 / 240 | PASS |
| Intermittend Operating Life MIL-STD-750 Method 1037 | IOL | Tj=175°C Cycle time: 2min | 1000 h | 4 x 60 | 0 / 240 | PASS |
| ESD (HBM) JESD22-A114B | HBM | ESD Class 1C | | 1 x 3 | 0 / 10 | PASS |

Environmental Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|-------|------------------------------------|----------|---------|----------|--------|
| Preconditioning J-STD020 / JESD22 A113 | PC | Soak acc.MSL1, 3x reflow, 260°C | | 4 x 240 | 0 / 960 | PASS |
| Temperature Cycling JESD22 A104 | TC | -55°C to +150°C | 1000 cyc | 4 x 60 | 0 / 240 | PASS |
| Autoclave JESD22 A102 | AC | Ta=121°C, RH=100% | 96 h | 4 x 60 | 0 / 240 | PASS |

Mechanical Stress Test Results:

| Test Description | Abbr. | Condition | Duration | Lots/SS | Fail/Qty | Result |
|---|-------|--|----------|---------|----------|--------|
| Destructive Physical Analysis | DPA | Random samples from H3TRB & TC | | 4 / 2 | 0 / 8 | PASS |
| Physical Dimensions JESD B-100 | PD | | | 1 / 30 | 0 / 30 | PASS |
| Resistance to Solder Heat JESD B-106 | RTSH | Solder bath Ts=260°C, dip 3 x 10 sec | | 1 / 30 | 0 / 30 | PASS |
| Solderability J-STD-002 | SD | | | 1 / 10 | 0 / 10 | PASS |

Notes:

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2016-01-22

Published by

Infineon Technologies AG
81726 München, Germany

© 2018 Infineon Technologies AG.
All Rights Reserved.

Do you have a question about this document?

Email: erratum@infineon.com

Document reference

n.a.

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (www.infineon.com).

WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.